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To: Commissioner of Patents and Trademarks  
Washington, D.C. 20231

ATTN: GROUP ART UNIT 1765 L. VINH

FR: Stephen B. Ackerman Reg. No. 37761  
28 Davis Avenue  
Poughkeepsie, N.Y. 12603

Subject:

Serial No. 09/579,542

05/26/00

Cheng Chung Lin and Lain-Jong Li

"Method to improve stability and reliability  
of CVD low k dielectric"

Grp. Art Unit :1765

L. Vinh

# RESPONSE TO FINAL PATENT OFFICE ACTION

Dear Sir:

In response to the Office Action dated January 29 2003, in the above identified application for patent, please enter the following amendments and consider the following remarks.

## CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231 on March 31, 2003.

Name Stephen B. Ackerman, Reg. #37,761

Signature/Date [Signature] 3/31/03